# Approved Meeting Minutes: IEEE 802.3 New Ethernet Applications Ad Hoc Interim Meeting

August 24, 2020 Telephonic Prepared by John D'Ambrosia

Monday August 24, 2020

Meeting Chaired by John D'Ambrosia

Meeting called to order at approximately 10:03am ET.

Mr. D'Ambrosia reminded the group that attendance for this meeting would use IMAT.

### Presentation #1 - General Information & Agenda

Presenter: John D'Ambrosia

URL: https://www.ieee802.org/3/ad hoc/ngrates/public/calls/20 0824/agenda nea 200824.pdf

Chair reviewed the meeting agenda and asked if there was any objection to approving the agenda as shown, none responded. Agenda was approved by unanimous consent.

Chair reviewed minutes for approval – July 27, 2020 Unapproved Minutes – <a href="https://www.ieee802.org/3/ad">https://www.ieee802.org/3/ad</a> hoc/ngrates/public/calls/20 0727/minutes nea a 200727 unapproved.pdf

- Chair noted that Xiang Zhou had submitted a post-presentation update to
   https://www.ieee802.org/3/ad hoc/ngrates/public/calls/20 0727/lam nea 01 200727.pdf, noting that in Slide #15 of the
   original presentation in the SiP-MZM insertion loss figure the two vendors had used different IL definitions, and it had not
   been noted. In the updated version the insertion loss figure has been updated by using the same IL definition.
- Chair suggested updating the webpage with the updated presentation and noting the update in the July 27 minutes. There were no objections.
- Chair asked if there were any additional changes to the minutes as posted, none responded.

Chair asked if there were any objections to approving the modified minutes, as described, and there were no objections. The minutes were approved by unanimous consent.

Chair asked if anyone needed to review the IEEE-SA policies that the meeting is run by which were sent with the meeting invitation, none responded.

## Presentation #2 - CMOS Technology Timelines

Presenter - Matt Brown

URL: https://www.ieee802.org/3/ad hoc/ngrates/public/calls/20 0824/brown nea 01 200824.pdf

General discussion regarding the presentation

Mr. D'Ambrosia asked Mr. Healey to chair meeting while he presented. Mr. Healey started chairing meeting at 10:32 am.

# Presentation #3 - Update - Draft CFI Consensus Deck - Beyond 400 GbE

Presenter – John D'Ambrosia

URL: https://www.ieee802.org/3/ad hoc/ngrates/public/calls/20 0824/dambrosia nea 01b 200824.pdf

General discussion and feedback about presentation.

It was noted that Slide #37 "Examples of Beyond 100 Gb/s Research" which the presenter was showing in ppt, but was not included in the posted pdf. Chair asked Mr. D'Ambrosia to upload the update including the slide (noted above).

Mr. D'Ambrosia requested any individuals interested in being listed as a supporter contact him via email.

Mr. D'Ambrosia resumed duties as the Chair @ 11:31am

Chair gave closing comments.

Meeting adjourned at 11:33 am.

# Attendees

Name Affiliation

Bhatt, Vipul Finisar Corporation

Brown, Matthew Huawei Technologies Canada

Carty, Clark Cisco Systems, Inc.
Chang, Yongmao Source Photonics

Chen, Chan Applied Optoelectronics, Inc.

Choudhury, Golam OFS

D'Ambrosia, John Futurewei (U.S. Subsidiary of Huawei)

Deandrea, John Finisar Corporation

Dudek, Michael Marvell Ewen, John Marvell

Ferretti, Vincent Corning Incorporated

Geng, Limin Huawei

Gustlin, Mark Cisco Systems, Inc.

He, Xiang HUAWEI Healey, Adam Broadcom Inc.

Huber, Thomas Nokia Hutchins, Jeff Ranovus

HYAKUTAKE, YASUHIRO Adamant Namiki Precision Jewel Co., Ltd.

Issenhuth, Tom Huawei Technologies Co. Ltd

Jackson, Kenneth Sumitomo Electric Industries, LTD

Johnson, John Broadcom Limited
Kabra, Lokesh Synopsys, Inc.
Kim, Inho Marvell

Kota, Kishore Inphi Corporation

Lam, Cedric Google
Lapierre, Dominic EXFO

Law, David Hewlett Packard Enterprise

Lewis, David Lumentum Inc.
Li, Mike-Peng Intel Corporation

Lingle, Robert OFS Mak, Gary inphi

Malicoat, David Malicoat Networking Solutions; SENKO Advanced Components

Maniloff, Eric Ciena Corporation
Marques, Flavio FURUKAWA ELECTRIC

Marris, Arthur Cadence Design Systems, Inc.

Mitcheltree, Tom US Conec, Ltd.

Muller, Shimon Axalume, Inc.

Nering, Raymond Cisco Systems, Inc.

Nicholl, Shawn Xilinx Noujeim, Leesa Google

Ofelt, David Juniper Networks, Inc.
Omori, Kumi NEC Corporation
Parsons, Earl CommScope, Inc.

Piehler, David Dell EMC
Pimpinella, Rick Panduit

Rabinovich, Rick Keysight Technologies

Ramesh, Sridhar Maxlinear Inc

Sambasivan, Sam AT&T Savi, Olindo Hubbell

Sekel, Steve Keysight Technologies

She, Qingya Fujitsu

Shukla, Priyank Synopsys, Inc.

Sommers, Scott Molex Incorporated

Sone, Yoshiaki Nippon Telegraph and Telephone Corporation (NTT)

Sorbara, Massimo GLOBALFOUNDIRES
Sprague, Edward Infinera Corporation

Stassar, Peter Huawei Technologies Co. Ltd

Stone, Robert Facebook Sun, Yi OFS

Swanson, John Synopsys, Inc.

Swanson, Steven Corning Incorporated TAKAHARA, TOMOO FUJITSU LIMITED Theodoras, James HG Genuine Tracy, Nathan TE Connectivity

Tran, Viet Keysight Technologies

Trowbridge, Stephen Nokia

Twombly, Jeff Credo Semiconductor

Vanderlaan, Paul UL LLC

Wang, Derek Centec Networks (Suzhou) Co., Ltd.

Wang, Ruoxu Huawei Wang, Xinyuan Huawei

Weber, Markus Acacia Communications
Withey, James Fluke Corporation

Young, James CommScope Zhou, Xiang Google

Zhuang, Yan Huawei Technologies Co. Ltd